blandt C 3:23:00

CERTIFICATE OF MAILING PURSUANT TO 37 C.F.R. §1.8

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Date:

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By Vamela B. Dennis

Pamela B. Dennis

MAR 2 0 2000 (1) N -

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Sugiyama, et al.

Serial No.: 08/960,431

Filed: FOR: October 10, 1997

FLATTENING METHOD AND

FLATTENING APPARATUS OF A SEMICONDUCTOR

DEVICE

Docket No.:

30598.0004 3723

Examiner:

Art Unit:

Nguyen, G.

PATENT

AMENDMENT

Box NON-FEE AMENDMENT Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir:

In response to the Office Actions dated July 12, 1999 and March 6, 2000, please amend the above-identified application as follows:

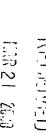
CLAIMS

1. (Twice Amended) A flattening method of a semiconductor device by a chemical-mechanical polishing process comprising,

preparing a synthetic resin polishing cloth in a circular form and a tool for forming a surface

layer of the synthetic resin polishing cloth to have fluff thereon in a polishing process, said tool having [an annular shape with] a diameter less than a radial length of the polishing cloth, and

rotating the polishing cloth along a central axis thereof and pressing the tool on a radial portion of the polishing cloth, said tool being moved along [a radial direction of] the polishing cloth [and perpendicular to the radial direction] to thereby



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RESPONSE TRANSMITTAL

Applicant(s):

Sugiyama, et al.

Docket No.:

30598.0004

Serial No.:

08/960,431

Group Art Unit:

3723

Filing Date:

October 10, 1997

Examiner:

Nguyen, G.

TITLE:

FLATTENING METHOD AND FLATTENING APPARATUS

OF A SEMICONDUCTOR DEVICE

0.00

Subtotal:

Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir/Madam:

In response to the Office Actions dated July 12, 1999 and March 6, 2000, please amend the above-identified application as follows:

FEE CALCULATION, CLAIMS AS AMENDED:

	Claims remaining after amendmen		Highest number previously paid for	Present Extra			Additional Fee
Total Effective Claims	21	minus	21=	0 x	\$ 18.00	=	0.00
Independent Claims	4	minus	4=	0 x	\$ 78.00	=	0.00
If amendment enters application for first t		•	•	s) into this	\$260.00	+	N/A

Fee Calculation: Request for Extension of Time pursuant to 37 C.F.R. §1.136(a)

[]	Response filed within first month aff	er due date - add	\$ 110.00					
[]	Response filed within second month	n after due date - add	\$ 380.00					
[]	Response filed within third month at	fter due date - add	\$ 870.00					
[]	Response filed within fourth month	after due date - add	\$1360.00					
[]	Response filed within fifth month aft	er due date - add	\$1850.00					
				TOTAL:	\$ 0.00				
		of the "small entity" boxes above is chall and subtract	necked, enter half (½) of	the second	N/A				
Information Disclosure Statement Pursuant to 37 C.F.R. §§1.97-1.98									
		TOTAL	ADDITIONAL FEE ENG	CLOSED:	<u>\$ 0.00</u>				
[]Please charge Deposit Account No. 08-2727 in the amount of \$ A duplicate copy of this sheet is attached.									
[]		Check No in the amou	unt of <u>\$</u> is atta	ached.					
the any onl C.F	fee / pa y) n .R.	This statement does NOT authorical authorized to charge any other fee sets) filed, or asserted to be filed, or where filed hereafter, and which may be sow or hereafter relative to this Applitus §1.20, or credit any overpayment ate copy of this sheet is attached.	pecifically authorized he hich should have been e required under 37 C.F cation and the resulting	ereafter, or any def filed herewith or c F.R. §§1.16-1.18 (d Official document	iciency in oncerning leficiency under 37				
			Respectfully submitted	1					
			By: R. Lee Fraley Reg. No. 42,556	ally					
CNI	- 1 '	9 WILMED LLD	Dated:						

SNELL & WILMER, L.L.P. One Arizona Center 400 East Van Buren Phoenix, Arizona 85004-0001 (602) 382-6305